

Low Capacitance, Low Charge Injection, ±15 V/+12 V, 4:1 *i*CMOS[™] Multiplexer

ADG1204

FEATURES

1.5 pF off source capacitance
<1 pC charge injection
33 V supply range
120 Ω on resistance
Fully specified at ±15 V, +12 V
No V_L supply required
3 V logic-compatible inputs
Rail-to-rail operation
14-lead TSSOP and 12-lead LFCSP_VQ
Typical power consumption < 0.03 μW

APPLICATIONS

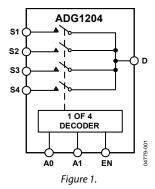
Automatic test equipment Data acquisition systems Battery-powered systems Sample-and-hold systems Audio signal routing Video signal routing Communication systems

GENERAL DESCRIPTION

The ADG1204 is a complementary metal-oxide semiconductor (CMOS) analog multiplexer, comprising four single channels designed on an *i*CMOS (industrial CMOS) process. *i*CMOS is a modular manufacturing process that combines high voltage CMOS and bipolar technologies. It enables the development of a wide range of high performance analog ICs capable of 33 V operation in a footprint that no previous generation of high voltage parts has been able to achieve. Unlike analog ICs using conventional CMOS processes, *i*CMOS components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduced package size.

The ultralow capacitance and charge injection of this multiplexer makes it an ideal solution for data acquisition and sample-andhold applications, where low glitch and fast settling are required. Fast switching speed coupled with high signal bandwidth makes the part suitable for video signal switching. *i*CMOS construction ensures ultralow power dissipation, making the part ideally suited for portable and battery-powered instruments.

FUNCTIONAL BLOCK DIAGRAM



The ADG1204 switches one of four inputs to a common output, D, as determined by the 3-bit binary address lines: A0, A1, and EN. Logic 0 on the EN pin disables the device. Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked. All switches exhibit break-before-make switching action.

PRODUCT HIGHLIGHTS

- 1. 1.5 pF off capacitance (±15 V supply).
- 2. <1 pC charge injection.
- 3. 3 V logic-compatible digital inputs: $V_{IH} = 2.0$ V, $V_{IL} = 0.8$ V.
- 4. No V_L logic power supply required.
- 5. Ultralow power dissipation: $<0.03 \mu$ W.
- 6. 14-lead TSSOP and 12-lead, 3 mm × 3 mm LFCSP_VQ packages.

Rev. A

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REVISION HISTORY

7/06—Rev. 0 to Rev. A	
Updated Format	Universal
Changes to Table 1	
Changes to Table 2	5
Changes to the Terminology Section	14

7/05—Revision 0: Initial Version

SPECIFICATIONS

DUAL SUPPLY

 V_{DD} = 15 V \pm 10%, V_{SS} = –15 V \pm 10%, GND = 0 V, unless otherwise noted.

Table 1.

. .	2505	Y Version ¹ -40°C to	-40°C to		
Parameter	25°C	+85℃	+125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	V	
On Resistance (R _{ON})	120			Ω typ	$V_s = \pm 10 V$, $I_s = -1 mA$; see Figure 21
	190	230	260	Ωmax	$V_{DD} = +13.5 \text{ V}, \text{ V}_{SS} = -13.5 \text{ V}$
On Resistance Match Between	3.5	4.0	10	Ω typ	$V_s = \pm 10 V$, $I_s = -1 mA$
Channels (ΔR_{ON})	6	10	12	Ωmax	
On Resistance Flatness (R _{FLAT(ON)})	20	70	70	Ω typ	$V_s = -5 V$, 0 V, +5 V; $I_s = -1 mA$
	57	72	79	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$
Source Off Leakage, Is (OFF)	±0.02			nA typ	$V_s = \pm 10 \text{ V}, V_D = \mp 10 \text{ V};$ see Figure 22
	±0.1	±0.6	±1	nA max	
Drain Off Leakage, I_D (OFF)	±0.02			nA typ	$V_{\text{S}}=\pm10$ V, $V_{\text{D}}=\mp10$ V; see Figure 22
	±0.1	±0.6	±1	nA max	
Channel On Leakage, I _D , I _S (ON)	±0.02			nA typ	$V_s = V_D = \pm 10 V$; see Figure 23
	±0.2	±0.6	±1	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current, I _{INL} or I _{NH}	0.005			μA typ	$V_{IN} = V_{INL}$ or V_{INH}
			±0.1	µA max	
Digital Input Capacitance, C _{IN}	2.5			pF typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time, t _{TRANS}	120			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	150	180	200	ns max	$V_s = 10 V$; see Figure 24
t _{on} (EN)	70			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	85	100	110	ns max	V _s = 10 V; see Figure 26
t _{off} (EN)	90			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
	110	135	155	ns max	$V_s = 10 V$; see Figure 26
Break-Before-Make Time Delay, t _D	25			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
			10	ns min	$V_{s1} = V_{s2} = 10 V$; see Figure 25
Charge Injection	-0.7			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 27
Off Isolation	85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28
Channel-to-Channel Crosstalk	80			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 30
Total Harmonic Distortion + Noise	0.15			% typ	$R_L = 10 \text{ k}\Omega$, 5 V rms, f = 20 Hz to 20 kHz; see Figure 31
Bandwidth –3 dB	800			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29
Cs (OFF)	1.2			pF typ	$f = 1 MHz, V_s = 0 V$
	1.5			pF max	$f = 1 MHz, V_s = 0 V$
C _D (OFF)	3.6			pF typ	$f = 1 MHz, V_s = 0 V$
	4.2			pF max	$f = 1 MHz, V_s = 0 V$
C _D , C _S (ON)	5.5			pF typ	$f = 1 MHz, V_s = 0 V$
	6.5			pF max	$f = 1 MHz$, $V_s = 0 V$

		Y Version ¹				
Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments	
POWER REQUIREMENTS					$V_{DD} = +16.5 \text{ V}, V_{SS} = -16.5 \text{ V}$	
I _{DD}	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$	
			1.0	μA max		
I _{DD}	170			μA typ	Digital inputs = 5 V	
			250	μA max		
Iss	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$	
			1.0	μA max		
I _{ss}	0.001			μA typ	Digital inputs = 5 V	
			1.0	μA max		

 1 Y version temperature range is $-40^\circ C$ to $+125^\circ C.$ 2 Guaranteed by design, not subject to production test.

SINGLE SUPPLY

 V_{DD} = 12 V \pm 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted. Table 2.

Y Version ¹							
Parameter	25°C	-40°C to	-40°C to	Unit	Test Conditions/Comments		
Parameter ANALOG SWITCH	25°C	+85°C	+125°C	Unit	rest Conditions/Comments		
			0 V to V _{DD}	v			
Analog Signal Range On Resistance (R _{ON})	200				$V_{1} = 0 V_{1} + 0 V_{1} = -1 m h$		
On Resistance (R _{ON})	300			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -1 mA$; see Figure 21		
	475	567	625	Ωmax	$V_{DD} = 10.8 V, V_{SS} = 0 V$		
On Resistance Match Between Channels	5			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -1 mA$		
(ΔR_{ON})	16	26	27	Ωmax			
On Resistance Flatness (R _{FLAT(ON)})	60			Ω typ	$V_s = 3 V, 6 V, 9 V; I_s = -1 mA$		
LEAKAGE CURRENTS					$V_{DD} = 13.2 \text{ V}$		
Source Off Leakage, Is (OFF)	±0.02			nA typ	$V_{s} = 1 \text{ V}/10 \text{ V}, V_{D} = 10 \text{ V}/1 \text{ V};$		
	±0.1	±0.6	±1	nA max	see Figure 22		
Drain Off Leakage, I _D (OFF)	±0.02			nA typ	$V_{s} = 1 \text{ V}/10 \text{ V}, V_{D} = 10 \text{ V}/1 \text{ V};$		
	±0.1	±0.6	±1	nA max	see Figure 22		
Channel On Leakage, I _D , Is (ON)	±0.02			nA typ	$V_{\text{S}} = V_{\text{D}} = 1 \text{ V or } 10 \text{ V}$; see Figure 23		
	±0.2	±0.6	±1	nA max			
DIGITAL INPUTS							
Input High Voltage, V _{INH}			2.0	V min			
Input Low Voltage, VINL			0.8	V max			
Input Current, I _{INL} or I _{INH}	0.001			μA typ	$V_{\text{IN}} = V_{\text{INL}} \text{ or } V_{\text{INH}}$		
			±0.1	μA max			
Digital Input Capacitance, C _{IN}	2.5			pF typ			
DYNAMIC CHARACTERISTICS ²							
Transition Time, t _{TRANS}	150			ns typ	$R_L=300~\Omega,~C_L=35~pF$		
	190	240	265	ns max	V _s = 8 V; see Figure 24		
t _{on} (EN)	95			ns typ	$R_L=300~\Omega,~C_L=35~pF$		
	120	150	170	ns max	Vs = 8 V; see Figure 26		
t _{off} (EN)	100			ns typ	$R_L=300~\Omega,~C_L=35~pF$		
	125	155	170	ns max	Vs = 8 V; see Figure 26		
Break-Before-Make Time Delay, t _D	50			ns typ	$R_L=300~\Omega,~C_L=35~pF$		
			10	ns min	$V_{S1} = V_{S2} = 8 V$; see Figure 25		
Charge Injection	-0.4			pC typ	$V_s = 6 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 27		
Off Isolation	85			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 28		
Channel-to-Channel Crosstalk	80			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 30		
Bandwidth –3 dB	550			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 29		
C _s (OFF)	1.2			pF typ	$f = 1 \text{ MHz}; V_s = 6 \text{ V}$		
	1.5			pF max	$f = 1 \text{ MHz}; V_{s} = 6 \text{ V}$		
C _D (OFF)	3.6			pF typ	$f = 1 MHz; V_s = 6 V$		
/	4.2			pF max	$f = 1 \text{ MHz}; V_s = 6 \text{ V}$		
C _D , C _s (ON)	5.5			pF typ	$f = 1 MHz; V_s = 6 V$		
, (+ ,	6.5			pF max	$f = 1 \text{ MHz}; V_s = 6 \text{ V}$		

		Y Version ¹			
Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
OWER REQUIREMENTS					V _{DD} = 13.2 V
I _{DD}	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
			1.0	µA max	
I _{DD}	170			μA typ	Digital inputs = 5 V
			250	μA max	

 1 Y version temperature range is $-40^\circ C$ to $+125^\circ C.$ 2 Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 3.

1 4010 51	
Parameter	Rating
V _{DD} to V _{SS}	35 V
V _{DD} to GND	–0.3 V to +25 V
V _{ss} to GND	+0.3 V to -25 V
Analog Inputs ¹	V _{ss} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	GND – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D	100 mA (pulsed at 1 ms, 10% duty cycle maximum)
Continuous Current	45 mA
Operating Temperature Range	
Automotive (Y Version)	–40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
14-Lead TSSOP, θ _{JA} Thermal	112°C/W
Impedance (4-Layer Board)	
12-Lead LFCSP_VQ, θ_{JA} Thermal	80°C/W
Impedance	
Reflow Soldering Peak	260°C
Temperature, Pb Free	

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating can be applied at any one time.

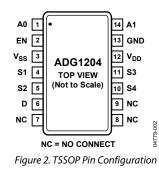
¹ Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



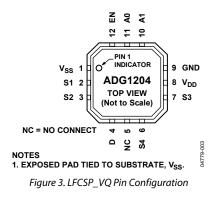


Table 4. Pin Function Descriptions

Ρ	in No.		
TSSOP	LFCSP_VQ	Mnemonic	Description
1	11	A0	Logic Control Input.
2	12	EN	Active High Digital Input. When low, the device is disabled and all switches are off. When high, Ax logic inputs determine on switches.
3	1	Vss	Most Negative Power Supply Potential.
4	2	S1	Source Terminal. Can be an input or an output.
5	3	S2	Source Terminal. Can be an input or an output.
6	4	D	Drain Terminal. Can be an input or an output.
7 to 9	5	NC	No Connection.
10	6	S4	Source Terminal. Can be an input or an output.
11	7	S3	Source Terminal. Can be an input or an output.
12	8	V _{DD}	Most Positive Power Supply Potential.
13	9	GND	Ground (0 V) Reference.
14	10	A1	Logic Control Input.

TRUTH TABLE Table 5.

Table 5.								
EN	A1	A0	S1	S2	S3	S4		
0	Х	Х	Off	Off	Off	Off		
1	0	0	On	Off	Off	Off		
1	0	1	Off	On	Off	Off		
1	1	0	Off	Off	On	Off		
1	1	1	Off	Off	Off	On		

TYPICAL PERFORMANCE CHARACTERISTICS

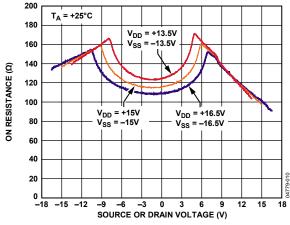
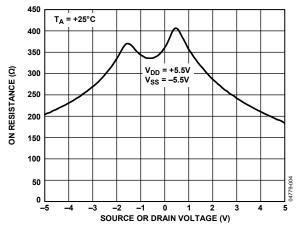


Figure 4. On Resistance as a Function of V_D (V_S), Dual Supply





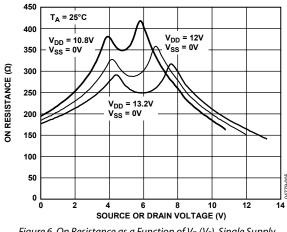


Figure 6. On Resistance as a Function of V_D (V_s), Single Supply

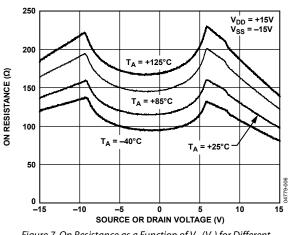


Figure 7. On Resistance as a Function of V_D (V_S) for Different Temperatures, Dual Supply

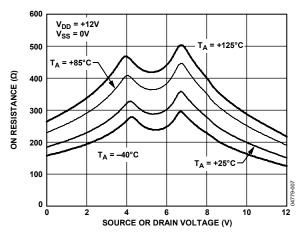


Figure 8. On Resistance as a Function of V_D (V_S) for Different Temperatures, Single Supply

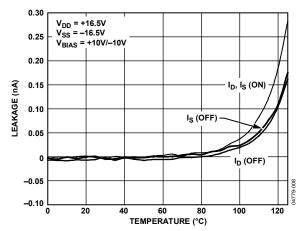


Figure 9. Leakage Currents as a Function of Temperature, Dual Supply

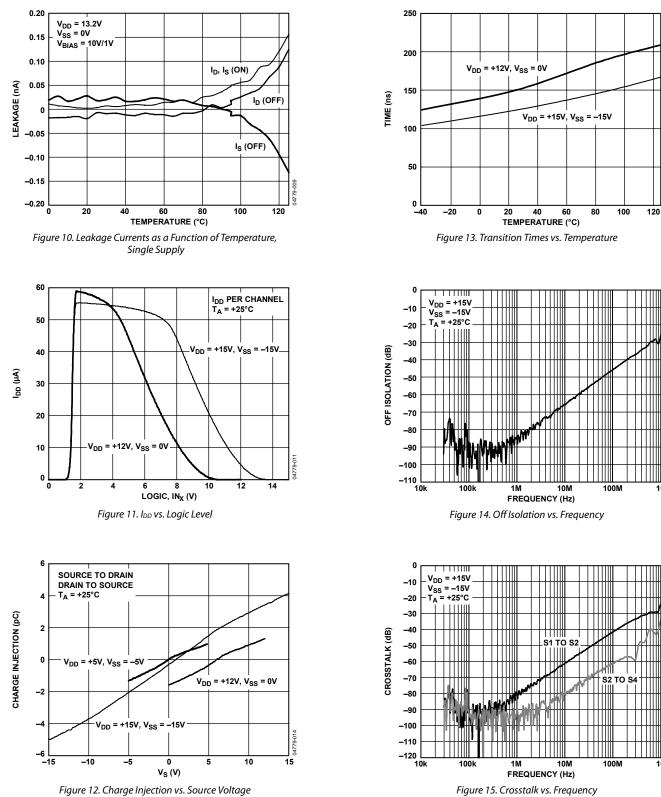
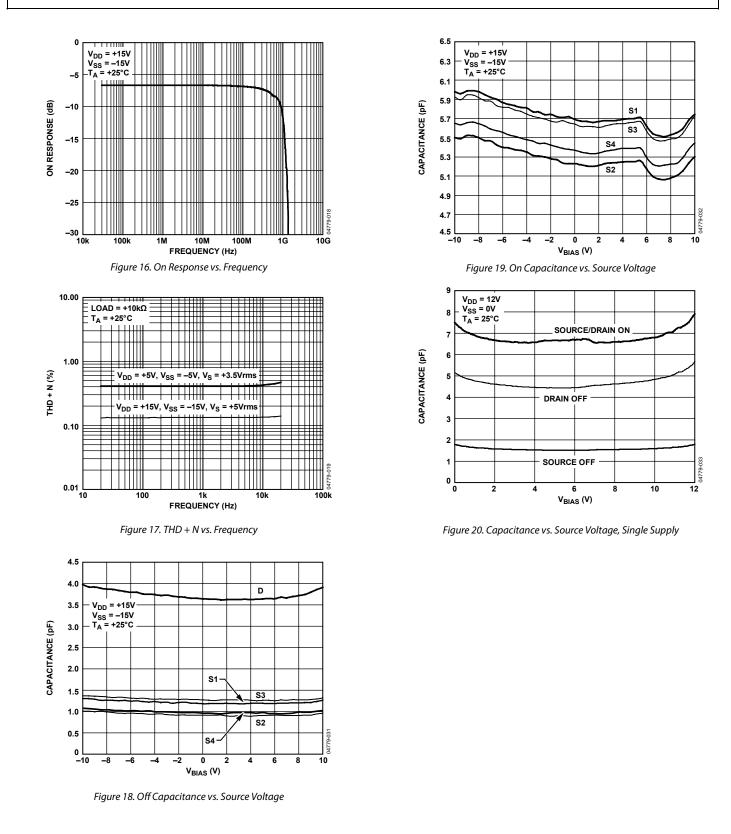


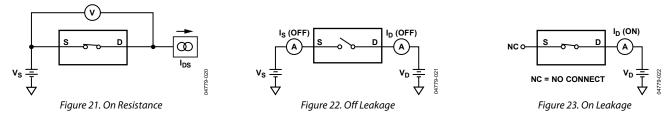
Figure 15. Crosstalk vs. Frequency

1G

1G



TEST CIRCUITS



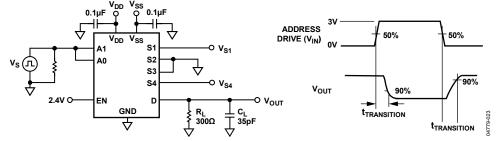


Figure 24. Address to Output Switching Times

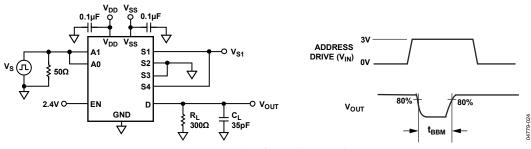
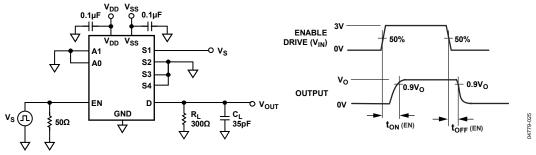
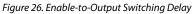
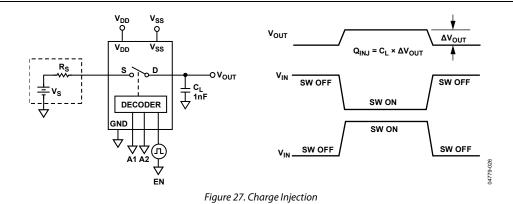


Figure 25. Break-Before-Make Time Delay







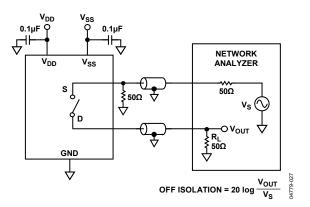


Figure 28. Off Isolation

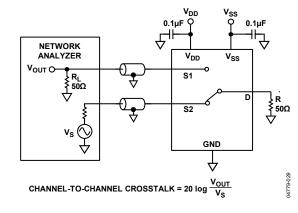
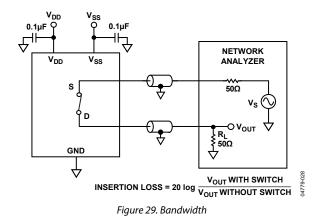
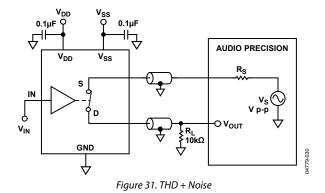


Figure 30. Channel-to-Channel Crosstalk





TERMINOLOGY

 \mathbf{I}_{DD} The positive supply current.

Iss The negative supply current.

 $\mathbf{V}_{\mathrm{D}}\left(\mathbf{V}_{s}\right)$ The analog voltage on Terminal D and Terminal S.

R_{ON} The ohmic resistance between D and S.

R_{FLAT(ON)}

Flatness is defined as the difference between the maximum and minimum value of on resistance, as measured over the specified analog signal range.

Is (OFF) The source leakage current with the switch off.

 \mathbf{I}_{D} (OFF) The drain leakage current with the switch off.

 $\mathbf{I}_{D},\,\mathbf{I}_{S}\left(ON\right)$ The channel leakage current with the switch on.

 $\label{eq:Vinl} V_{\text{INL}}$ The maximum input voltage for Logic 0.

 \mathbf{V}_{INH} The minimum input voltage for Logic 1.

 $I_{\text{INL}}\left(I_{\text{INH}}\right)$ The input current of the digital input.

Cs (OFF)

The off switch source capacitance, which is measured with reference to ground.

C_D (**OFF**) The off switch drain capacitance, which is measured with reference to ground. C_D, C_s (On) The on switch capacitance, measured with reference to ground.

 $C_{\rm IN}$ The digital input capacitance.

ton (EN) The delay between applying the digital control input and the output switching on.

t_{OFF} (EN) The delay between applying the digital control input and the output switching off.

t_{TRANS}

The delay time between the 50% and 90% points of the digital input and switch on condition when switching from one address state to another.

Charge Injection

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

Off Isolation

A measure of unwanted signal coupling through an off switch.

Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Bandwidth The frequency at which the output is attenuated by -3 dB.

On Response The frequency response of the on switch.

Insertion Loss The loss due to the on resistance of the switch.

Total Harmonic Distortion + Noise (THD + N)

The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

OUTLINE DIMENSIONS

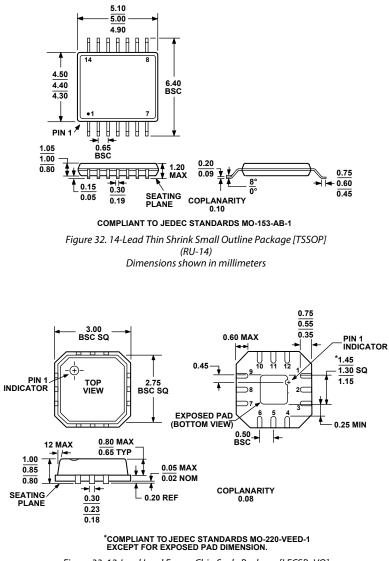


Figure 33. 12-Lead Lead Frame Chip Scale Package [LFCSP_VQ] 3 mm × 3 mm Body, Very Thin Quad (CP-12-1) Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
ADG1204YRUZ ¹	-40°C to +125°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14
ADG1204YRUZ-REEL ¹	-40°C to +125°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14
ADG1204YRUZ-REEL71	-40°C to +125°C	14-Lead Thin Shrink Small Outline Package (TSSOP)	RU-14
ADG1204YCPZ-500RL71	-40°C to +125°C	12-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-12-1
ADG1204YCPZ-REEL71	-40°C to +125°C	12-Lead Lead Frame Chip Scale Package (LFCSP_VQ)	CP-12-1

 1 Z = Pb-free part.

NOTES

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